

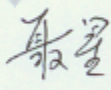
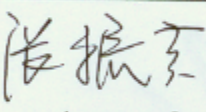

MODEL NO. : TM070RBH01ISSUED DATE: 2009-12-14VERSION : Ver 2.2

- ☐ Preliminary Specification
☒ Final Product Specification

Customer : _____

Approved by	Notes

SHANGHAI TIANMA Confirmed :

Prepared by	Checked by	Approved by
 2010.1.13	 2010-01-13	

This technical specification is subjected to change without notice

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Record of Revision

[illegible]



1 General Specifications

Feature		Spec
Display Spec.	Size	6.95 inch
	Resolution	800(RGB) x 480
	Interface	RGB18 bits without TCON
	Color Depth	262K
	Technology Type	a-Si
	Pixel Pitch (mm)	0.1965x0.1715
	Pixel Configuration	R.G.B. Vertical Stripe
	Display Mode	TM with Normally White
	Surface Treatment(Up Polarizer)	Anti Glare
	Surface Treatment(TSP)	Anti Glare
	Viewing Direction	12 o'clock
	Gray Scale Inversion Direction	6 o'clock
Mechanical Characteristics	LCM (W x H x D) (mm)	167.40x93.70x4.69
	Active Area(mm)	157.20x82.32
	With /Without TSP	With TSP
	Weight (g)	146.5
	LED Numbers	27 LEDs

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: +/- 5%



2 Input/Output Terminals

TFT-LCD Panel Driving

Matching Connector of SUNCAGEY BL114-35-RU-TAND

J1 of FPC2

Pin	Symbol	I/O	Description	Remark
1	LED+	P	LED Anode	
2	NC	N	No connection	
3	LED1-	P	LED Cathode	
4	LED2-	P	LED Cathode	
5	LED3-	P	LED Cathode	
6	DIO1	I/O	Horizontal start pulse signal	Note2
7	VSS1	P	Ground	Note1
8	VDD1	P	Power supply	Note1
9	CLK	I	Horizontal shift clock	
10	VSS1	P	Ground	Note1
11	R/L	I	Right/left selection	Note2
12	R0	I	Red data(LSB)	
13	R1	I	Red data	
14	R2	I	Red data	
15	R3	I	Red data	
16	R4	I	Red data	
17	R5	I	Red data	
18	VSS1	P	Ground	Note1
19	G0	I	Green data(LSB)	
20	G1	I	Green data	
21	G2	I	Green data	
22	G3	I	Green data	
23	G4	I	Green data	
24	G5	I	Green data	
25	VSS1	P	Ground	Note1
26	B0	I	Blue data(LSB)	
27	B1	I	Blue data	



28	B2	I	Blue data	
29	B3	I	Blue data	
30	B4	I	Blue data	
31	B5	I	Blue data	
32	LD	I	Load output signal	Note2
33	REV	I	Data invert control	
34	POL	I	Polarity selection	
35	DIO2	I/O	Horizontal start pulse signal	Note2

J2 of FPC1

Pin	Symbol	I/O	Description	Remark
1	VSS2	P	Ground	Note1
2	V1	I	Gamma voltage 1	Note1
3	V2	I	Gamma voltage 2	
4	V3	I	Gamma voltage 3	
5	V4	I	Gamma voltage 4	
6	V5	I	Gamma voltage 5	
7	V6	I	Gamma voltage 6	
8	V7	I	Gamma voltage 7	
9	VSS2	P	Ground	Note1
10	V8	I	Gamma voltage 8	
11	V9	I	Gamma voltage 9	
12	V10	I	Gamma voltage 10	
13	V11	I	Gamma voltage 11	
14	V12	I	Gamma voltage 12	
15	V13	I	Gamma voltage 13	
16	V14	I	Gamma voltage 14	
17	VSS2	P	Ground	Note1
18	VDD2	P	Voltage for analog circuit	Note1
19	VCOM	P	Common voltage	
20	XON	N	No connection	
21	OE	I	Output enable	Note1



22	U/D	I	Up/down selection	Note2
23	CKV	I	Vertical shift clock	Note1
24	STVU	I/O	Vertical shift pulse signal	Note1,2
25	STVD	I	Vertical shift pulse signal	Note2
26	VGG	P	Gate on voltage	
27	GND	P	Ground	
28	VCC	P	Voltage for logic circuit	
29	GND	P	Ground	
30	VEE	P	Gate off voltage	
31	NC	N	No connection	
32	XL	P	Touch panel left	
33	YD	P	Touch panel down	
34	XR	P	Touch panel right	
35	YU	P	Touch panel up	

Note1: I/O definition.

I---Input pin, O---Output pin, P--- Power/Ground, N--- No connection

Note2:

Scan Control Input		IN/OUT State For Start Pulse				Scanning Direction
U/D	R/L	STVD	STVU	DIO2	DIO1	
GND	VCC	O	I	O	I	Up to down, left to right
VCC	GND	I	O	I	O	Down to up, right to left
GND	GND	O	I	I	O	Up to down, right to left
VCC	VCC	I	O	O	I	Down to up, left to right



3 Absolute Maximum Ratings

VSS1=VSS2=GND=0V, Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
Power Voltage	VCC	-0.50	5.00	V	
	VDD1	-0.50	5.00	V	
	VDD2	-0.50	13.50	V	
	VGG	-0.30	40.00	V	
	VEE	-20.00	0.30	V	
	VGG-VEE	-0.30	40.00	V	
Touch Panel Forward Voltage	V _{TP}	-	7.0	V	
Backlight Forward Current	I _{LED}	-	25.0	mA	For each LED
Operating Temperature	T _{OPR}	-20	60	°C	
Storage Temperature	T _{STG}	-30	70	°C	



4 Electrical Characteristics

4.1 Recommended Operating Condition

VSS1=VSS2=GND=0V, Ta = 25°C

Item		Symbol	Min	Typ	Max	Unit	Remark
Digital Supply Voltage		VDD1	3.00	3.30	3.60	V	
Digital Supply Voltage		VCC	3.00	3.30	3.60	V	
Analog Supply Voltage		VDD2	9.45	9.84	10.23	V	
Gate On Voltage		VGG	17.10	19.00	20.90	V	
Gate Off Voltage		VEE	-7.70	-7.00	-6.30	V	
Common Electrode Driving Signal		VCOM	-	4.21	-	V	
Input Level Of Gamma Voltage		V1~V7	0.4xAVDD	-	VDD2-0.1	V	
		V8~V14	0.10	-	0.6xVDD2	V	
Input Signal Voltage	Low Level	V _{IL}	0	-	0.2xVDD1	V	CLK,R/L,R0~R5,G0~G5, DIO1,B0~B5,LD,REV, POL,DIO2,V1~V14,OE, U/D,CKV,STVD,STVU,
	High Level	V _{IH}	0.8xVDD1	-	VDD1	V	
Output Signal Voltage	Low Level	V _{OL}	0	-	0.2xVDD1	V	STVU,DIO2,DIO1
	High Level	V _{OH}	0.8xVDD1	-	VDD1	V	

Note: The value is for design stage only.

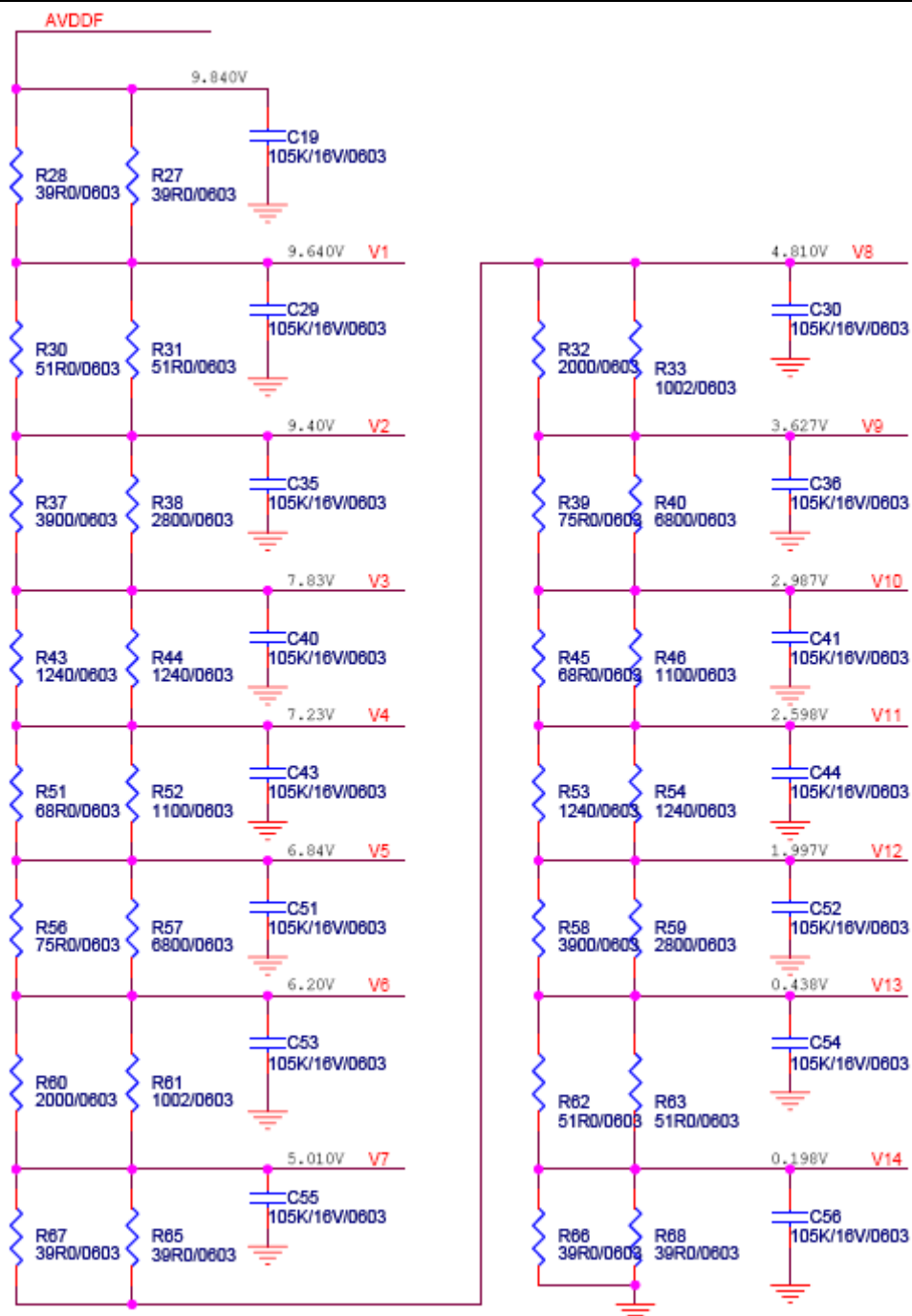


4.2 Gamma Correction Reference Voltage Setting

Parameter	Symbol	Min	Typ	Max	Unit	Remark
Gamma correction reference voltage V1~V14	V1	-	9.640	VDD2-0.1	V	
	V2	-	9.400	-	V	
	V3	-	7.830	-	V	
	V4	-	7.230	-	V	
	V5	-	6.840	-	V	
	V6	-	6.200	-	V	
	V7	-	5.010	-	V	
	V8	-	4.810	-	V	
	V9	-	3.627	-	V	
	V10	-	2.987	-	V	
	V11	-	2.598	-	V	
	V12	-	1.997	-	V	
	V13	-	0.438	-	V	
	V14	VSS2+0.1	0.198	-	V	

Note: the value is for design stage only;

VDD2-0.1>V1>V2>V3>V4>V5>V6>V7, V8>V9>V10>V11>V12>V13>V14>VSS2+0.1



NOTE: The gamma circuit only apply to AVDD=9.840V, Connect LCM to the gamma circuit and keep LCM operation, you can get correct gamma voltage, V1=9.64V、V2=9.40V etc.



4.3 Recommended Driving Condition for Backlight

Ta=25℃

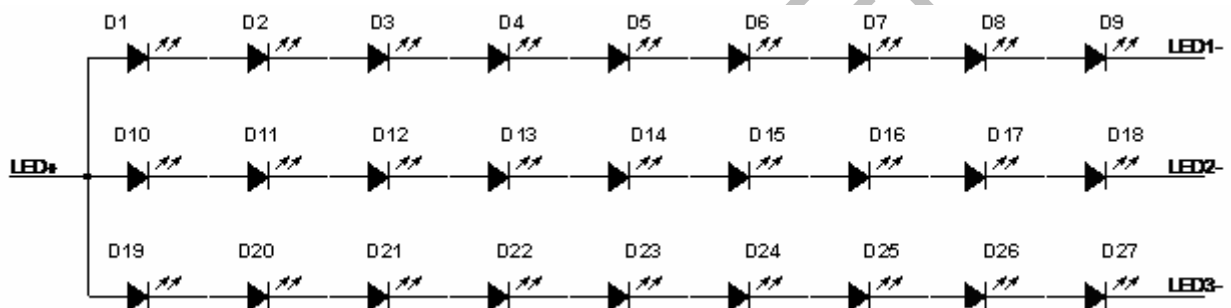
Item	Symbol	Min	Typ	Max	Unit	Remark
Forward Current	I_{LED}	-	60.00	75.00	mA	
Forward Voltage	V_{LED}	27.45	28.80	31.05	V	
Power Consumption	P_{BL}	-	1.73	2.33	W	
Operating Life Time	--	10000	(20000)	--	hrs	

Note1: The LED driving condition is defined for each LED module (9 LED Serial, 3 LED Parallel) .

Input current = 20 mA x 3 = 60 mA

Note2: Under LCM operating, the stable forward current should be inputted. And forward voltage is for reference only.

Note3: The LED driving condition is defined for each LED module.



Note 4: I_F is defined for one channel LED.

Optical performance should be evaluated at Ta=25℃ only.

If LED is driven by high current, high ambient temperature & humidity condition.

The life time of LED will be reduced.

Operating life means brightness goes down to 50% initial brightness.

Typical operating life time is estimated data.



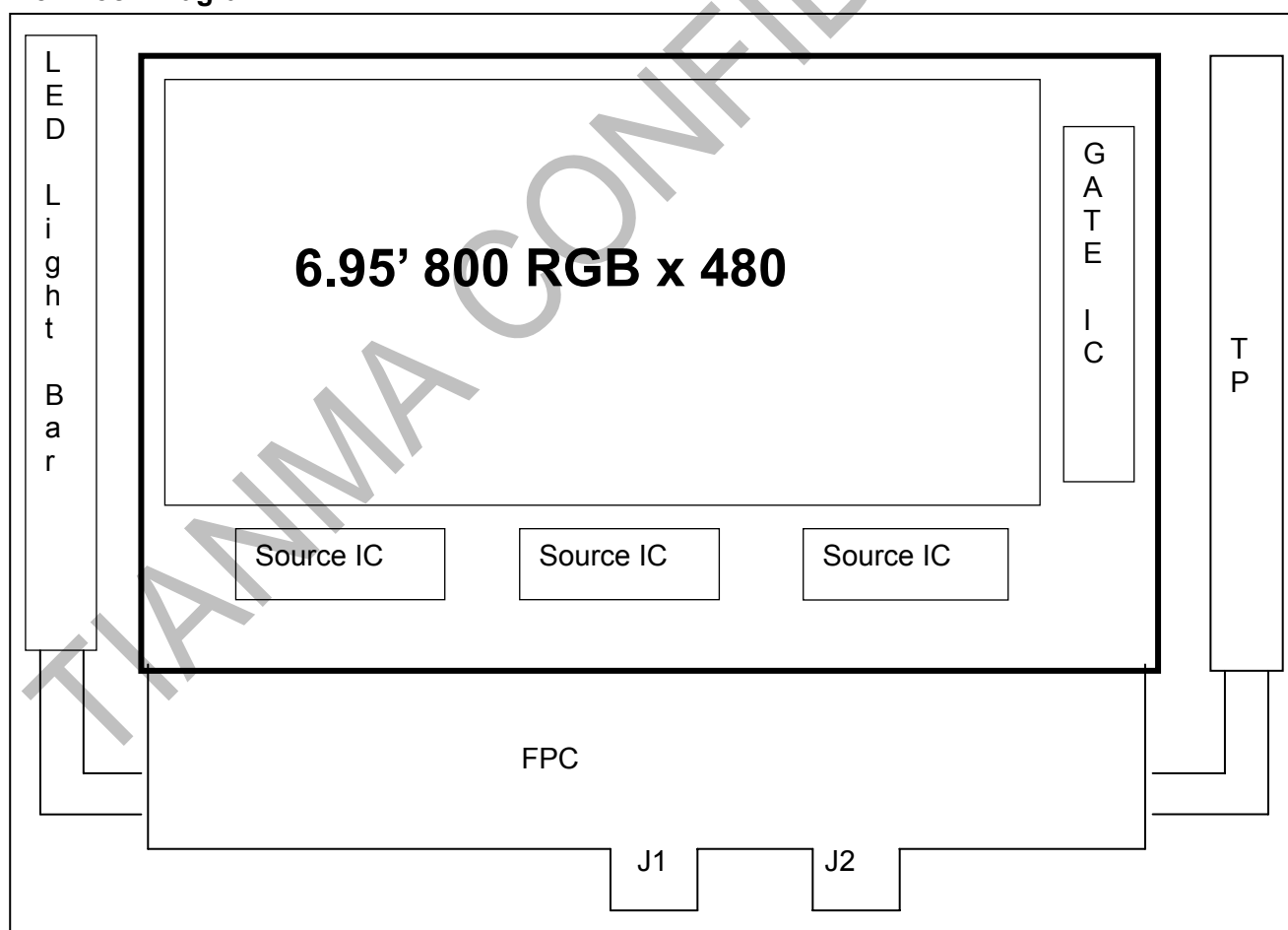
4.4 Power Consumption

VSS1=VSS2=GND=0V, Ta = 25°C

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark
Digital Supply Current	I _{VDD1}	VDD1=3.3V	-	3.50	5.16	mA	
Digital Supply Current	I _{VCC}	VCC=3.3V	-	3.50	5.16	mA	
Analog Supply Current	I _{VDD2}	VDD2=9.84V	-	39.00	56.00	mA	
Gate On Current	I _{VGG}	VGG=19.0V	-	0.22	0.40	mA	
Gate Off Current	I _{VEE}	VEE=-7.0V	-	0.22	0.40	mA	
Power Consumption	Panel &gamma		-	0.42	0.60	W	
	Backlight		-	1.73	2.33	W	
	Total		-	2.15	2.93	W	

Note: Analog Supply Current and Power Consumption condition is defined as colorbar pattern and with gamma circuit.

4.5 Block Diagram





5 Timing Chart

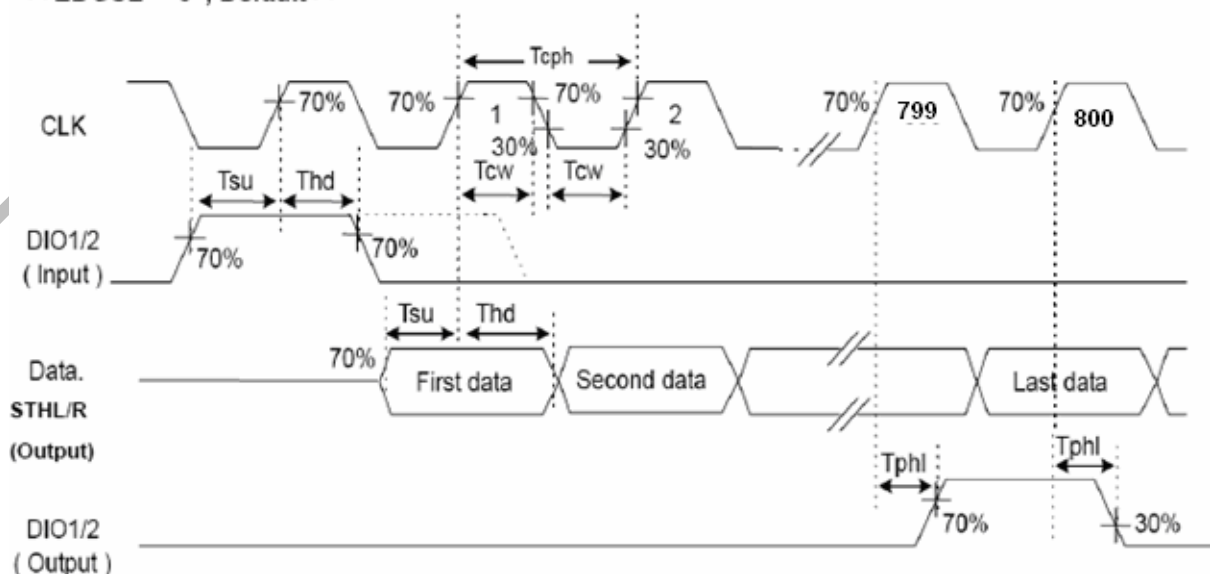
5.1 Source Driver Input Timing

(VDD1=3.3V, VDD2=9.84V, VSS1=VSS2=GND=0V, Ta=25°C)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
CLK frequency	Fclk	-	33.3	40.0	MHz	EDGSL="0"
CLK high/low Pulse Width	Tcw	10	-	-	ns	Tcph is CLK cycle 1 Tcw=1/Fclk
Data Set-up Time	Tsu	6	-	-	ns	R0~R5 , G0~G5 , B0~B5 , REV and DIO1/2 to CLK
Data Hold Time	Thd	4	-	-	ns	R0~R5 , G0~G5 , B0~B5 , REV and DIO1/2 to CLK
Propagation delay of STHR/L	Tphl	5	10	15	ns	CL=25pF
Time that the last data to LD	Tld	1	-	-	Tcph	
Pulse width of LD	Twld	2	-	-	Tcph	
Time that LD to STHL/R	Tlds	5	-	-	Tcph	
POL set-up time	Tpsu	6	-	-	ns	POL to LD
POL hold time	Tphd	6	-	-	ns	POL to LD
Output stable time	Tst	-	-	12	us	10% or 90% Target voltage. CL=60pF, R=2Kohm

5.1.1 EDGSL='0', Source Driver Input Timing

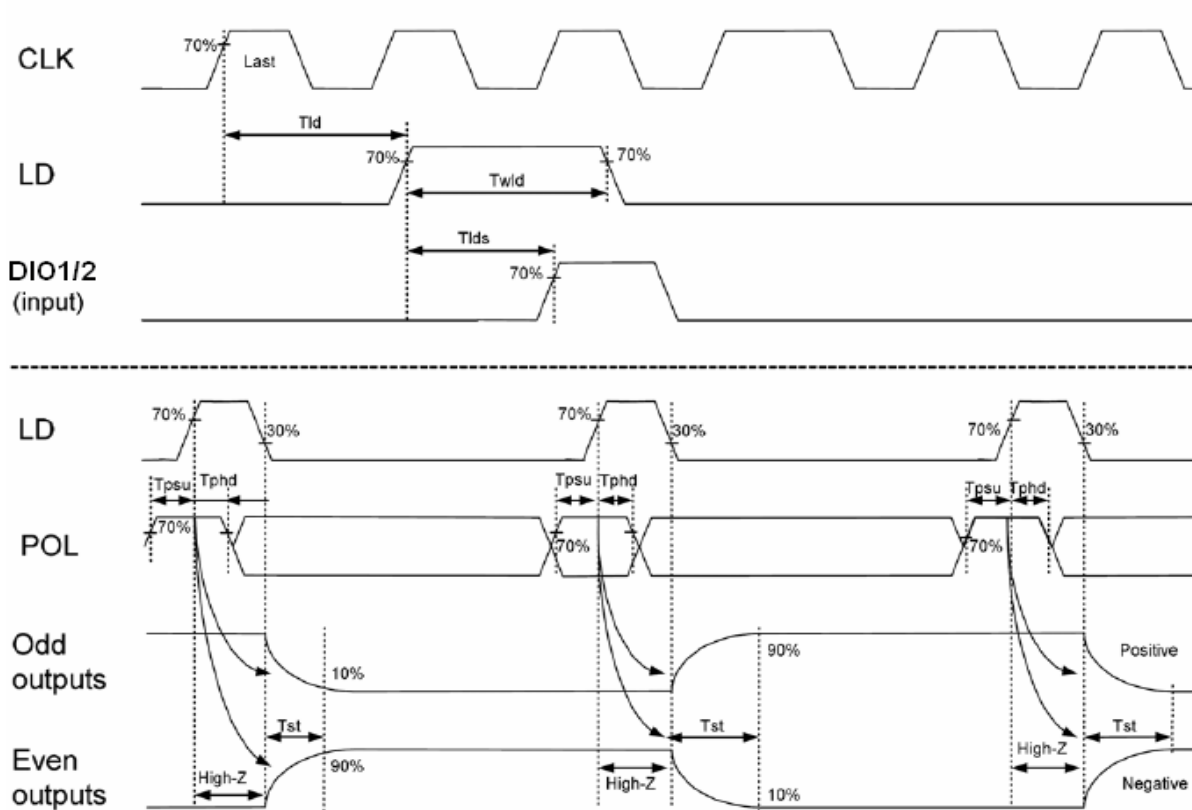
<< EDGSL= "0", Default >>



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5.1.2 Source Driver Input Timing



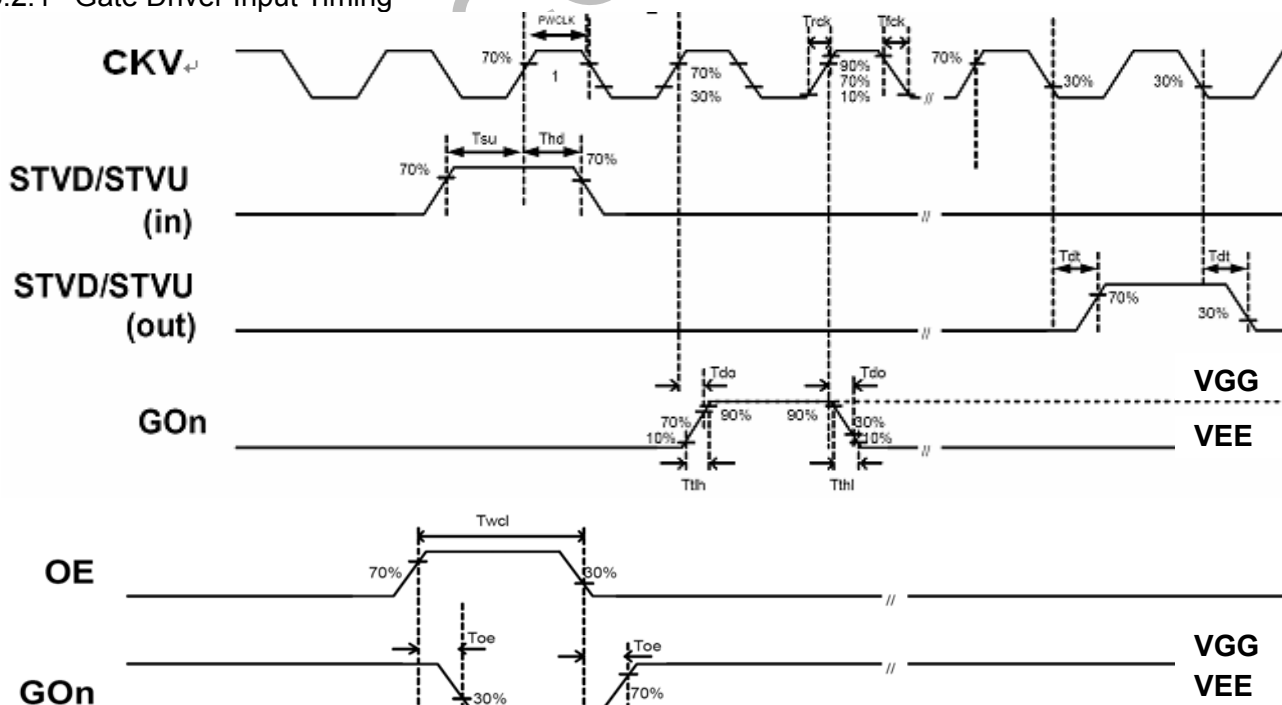


5.2 Gate Driver Input Timing

(VGG=19V, VEE=-7V, VDD1=3.3V, VSS1=GND=0V, Ta=25°C)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
STVD/STVU Delay Time	Tdt	-	-	500	ns	CL=20pF
Driver Output Delay Time	Tdo	-	-	900	ns	CL=200pF
Output Falling Time	Tthl	-	400	800	ns	CL=200pF 90% to 10%
Output Rising Time	Ttlh	-	500	1000	ns	CL=200pF 10% to 90%
XON To Driver Output Delay Time	Txon	-	-	20	ns	CL=200pF
OE To Driver Output Delay Time	Toe	-	-	900	ns	CL=200pF
Clock Frequency	Fclk	-	-	200	KHz	In cascade connection
Clock Rising Time	Trck	-	-	100	ns	CL=20pF
Clock Falling Time	Tfck	-	-	100	ns	CL=20pF
Clock Pulse Width(High & Low)	PWCLK	500	-	-	ns	
STVD/STVU Set-up Time	Tsu	200	-	-	ns	
STVD/STVU Hold Time	Thd	300	-	-	ns	
Output Enable Pulse Width	Twcl	1	-	-	us	

5.2.1 Gate Driver Input Timing



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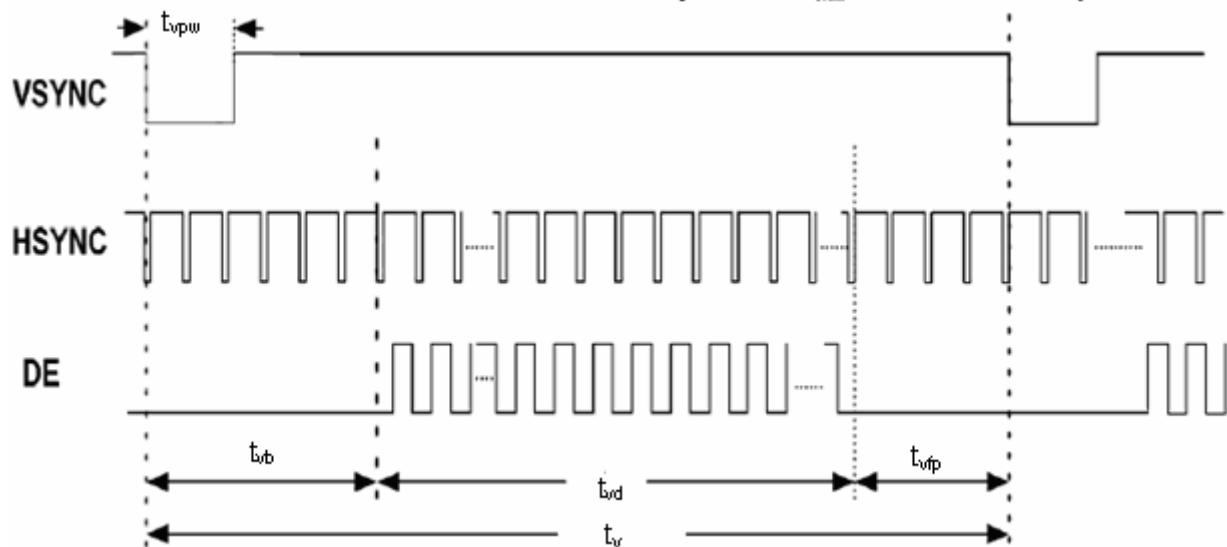
5.3 Recommended Timing Setting Of TCON At HV Mode

5.3.1 DCLK/ HSYNC/ VSYNC Timing

Parameter	Symbol	Min	Typ	Max	Unit	Remark
DCLK	Fclk	26.4	33.3	40.0	MHZ	
	Tclk	37.9	30.0	25.0	ns	
HSYNC	t_h	862	1056	1200	Tclk	
	t_{hd}	800	800	800	Tclk	
	t_{hpw}	1	-	40	Tclk	
	t_{hb}	46	46	46	Tclk	
	t_{hfp}	16	210	354	Tclk	
VSYNC	t_v	510	525	650	th	
	t_{vd}	480	480	480	th	
	t_{vpw}	1	-	20	th	
	t_{vb}	23	23	23	th	
	t_{vfp}	7	22	147	th	

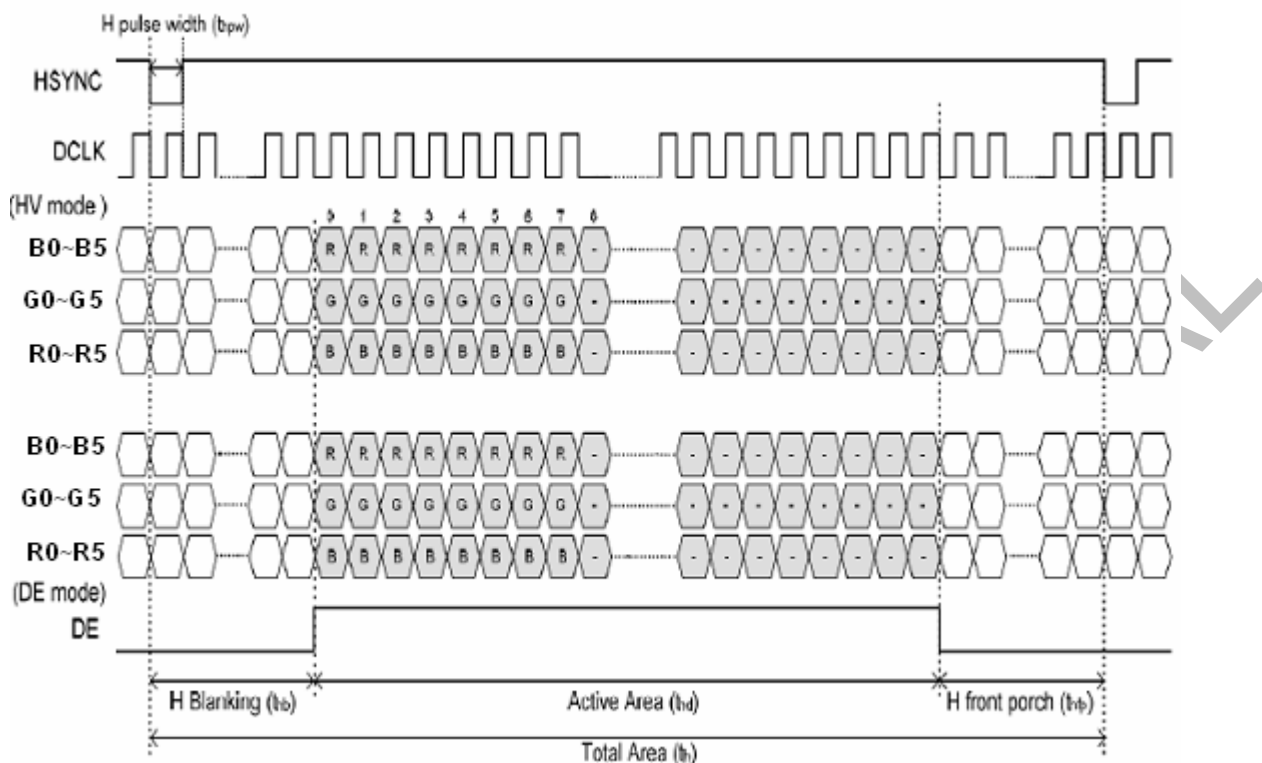
Note: Base on TCON NT39703-5

5.3.2 Vertical Input Timing

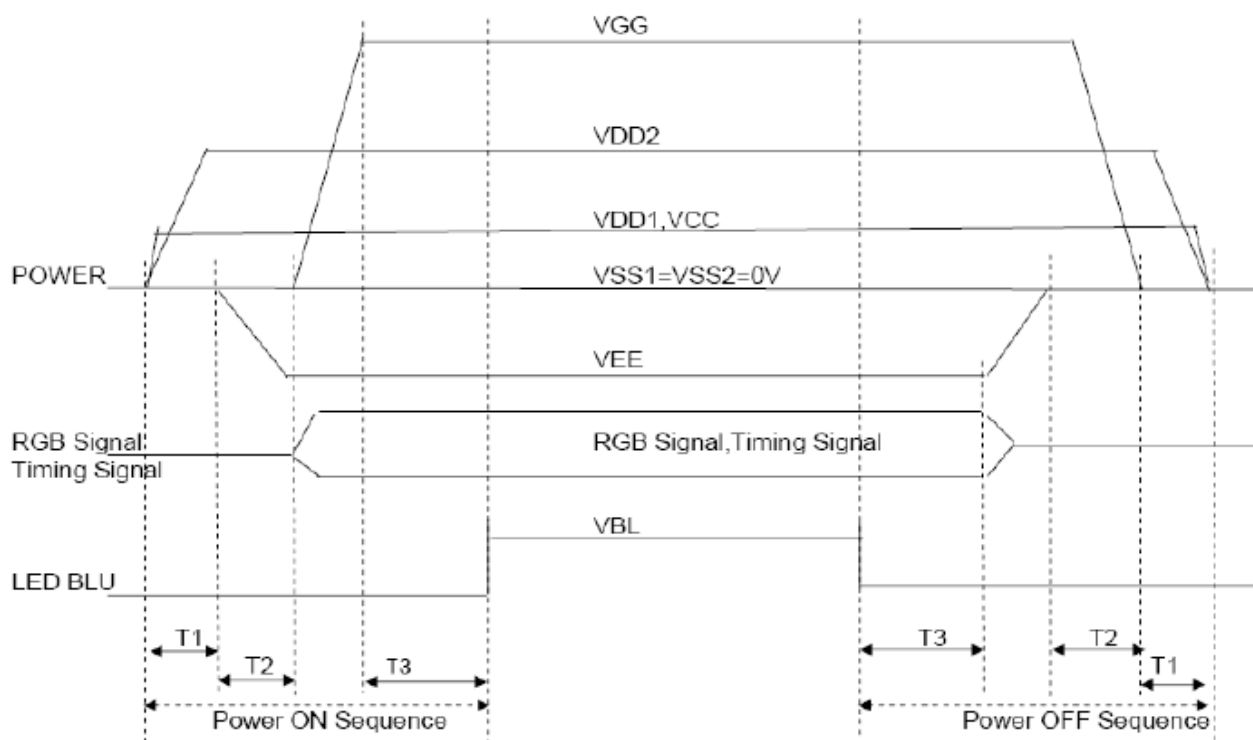




5.3.3 Horizontal Input Timing



5.4 Power On/Off Sequence



NOTE: $T1 \geq 10ms$; $T2 \geq 20ms$; $T3 \geq 100ms$;



6 Optical Characteristics

Ta=25℃

Item		Symbol	Condition	Min	Typ	Max	Unit	Remark
View Angles		θT	CR≧10	50	60	-	Degree	Note2,3
		θB		60	70	-		
		θL		60	70	-		
		θR		60	70	-		
Contrast Ratio		CR	θ=0°	300	400	-		Note 3
Response Time		T _{ON}	25℃	-	25	40	ms	Note 4
		T _{OFF}						
Chromaticity	White	x	Backlight is on	0.271	0.321	0.371		Note 1,5
		y		0.298	0.348	0.398		
	Red	x		0.528	0.578	0.628		Note 1,5
		y		0.302	0.352	0.402		
	Green	x		0.293	0.343	0.393		Note 1,5
		y		0.532	0.582	0.632		
	Blue	x		0.096	0.146	0.196		Note 1,5
		y		0.056	0.106	0.156		
Uniformity		U		70	80	-	%	Note 6
NTSC				-	50	-	%	Note 5
Luminance (with TSP)		L		220	280	-	cd/m ²	Note 7

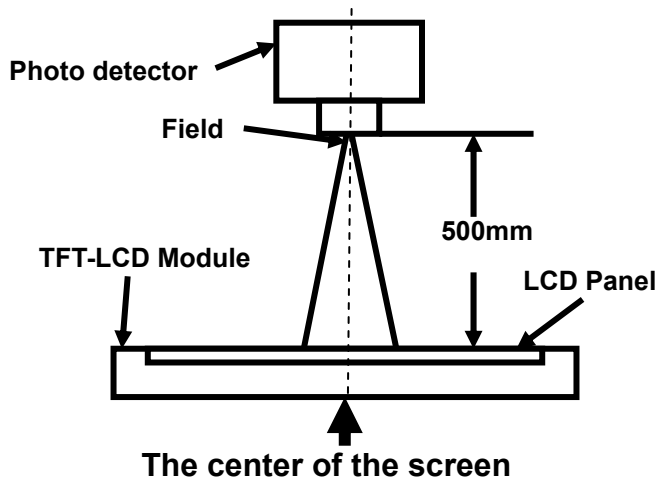
Test Conditions:

1. $I_F = 20$ mA, and the ambient temperature is 25℃.
2. The test systems refer to Note 1 and Note 2.



Note 1: Definition of optical measurement system.

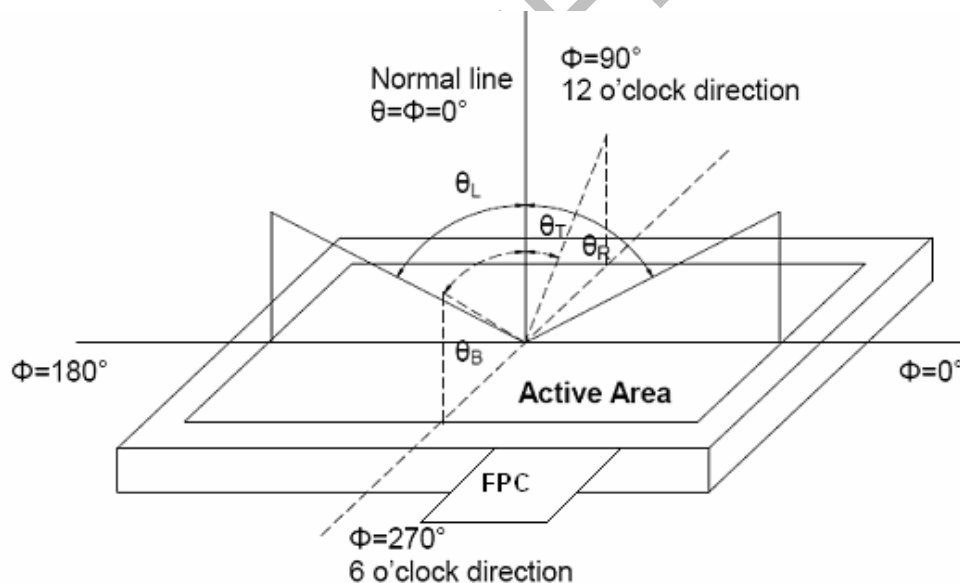
The optical characteristics should be measured in dark room. After 5 Minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Item	Photo detector	Field
Contrast Ratio	SR-3A	1°
Luminance		
Chromaticity		
Lum Uniformity		
Response Time	BM-7A	2°

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).



Note 3: Definition of contrast ratio

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$$

"White state ": The state is that the LCD should drive by V_{white} .

"Black state": The state is that the LCD should drive by V_{black} .

V_{white} : To be determined V_{black} : To be determined.

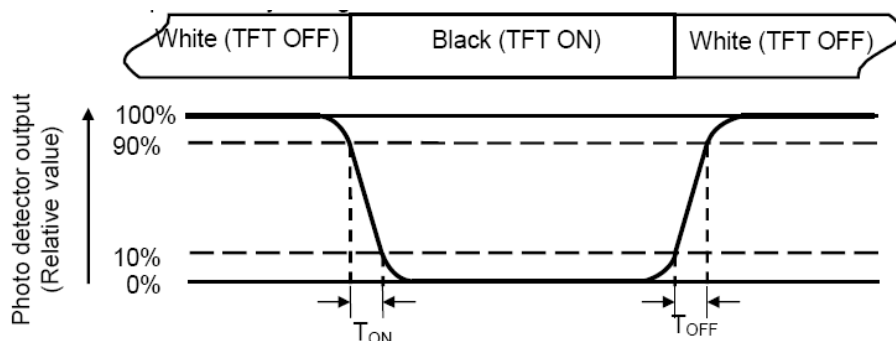
Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and

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"Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

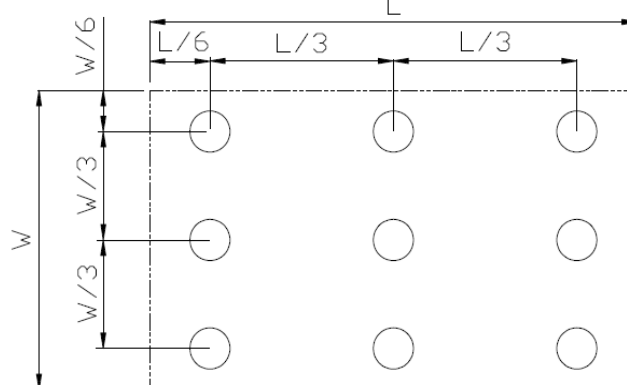
Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity (U)} = L_{\min} / L_{\max}$$

L-----Active area length W----- Active area width



L_{\max} : The measured Maximum luminance of all measurement position.

L_{\min} : The measured Minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



7 Environmental / Reliability Test

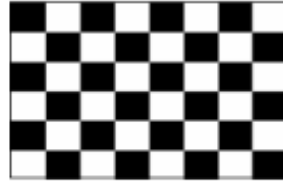
No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts = +60℃, 240 hours	Note1 IEC60068-2-1,GB2423.2
2	Low Temperature Operation	Ta = -20℃, 240 hours	IEC60068-2-1 GB2423.1
3	High Temperature Storage	Ta = +70℃, 240 hours	IEC60068-2-1 GB2423.2
4	Low Temperature Storage	Ta = -30℃, 240 hours	IEC60068-2-1 GB2423.1
5	Operation at High Temperature and Humidity	Ta = +40℃, 90% RH max,240hours	Note2 IEC60068-2-78 GB/T2423.3
6	Thermal Shock (non-operation)	-20℃ 30 min~+60℃ 30 min, Change time:5min, 30 Cycle	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22
7	Electro Static Discharge (Operation)	C=150pF,R=330Ω,5point/panel Air:±8Kv,5times; Contact:±4Kv,5times	IEC61000-4-2 GB/T17626.2
8	Vibration (Non-operation)	Sine Wave Frequency range:10~55Hz Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)	IEC60068-2-6 GB/T2423.10
9	Shock (Non-operation)	Half Sine Wave 60G 6ms, ±X,±Y,±Z 3times for each direction	IEC60068-2-27 GB/T2423.5
10	Package Drop Test	Height:60cm, 1corner,3edges,6surfaces	IEC60068-2-32 GB/T2423.8
11	Baseline Function Test	Room Temp 72 hours	Note3
12	Operating Temp & Humidity Test	Temp -20℃~+60℃, Humi 0~90%RH,96 hours	Note3
13	Storage Test	Temp -40℃~+75℃, Humi 0~90%RH,96 hours	Note3
14	Thermal Shock Test	-20℃~+60℃, 10 cycle -40℃~+75℃, 10 cycle	Note3
15	Image Sticking	Room Temp,24 hours	Note4

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of samples.

Note3: The conditions is requested by MITAC.

Note4: Image Sticking Bum In Pattern is the following Cross pattern. And check patterns are Full Screen White, Red, Blue, Green and Black Pattern.



Cross Pattern

Judgment:

Main LCD should work under the normal condition.

After the temperature and humidity test, the luminance and CR (Contrast Ratio) should not be changed over 50% compared with those before the test.

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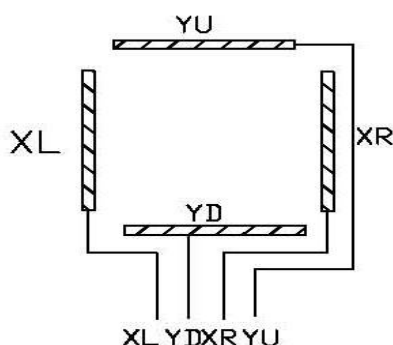
8 Touch Screen Panel

8.1 Electrical Characteristics

Item	Min	Typ	Max	Unit	Remark
Linearity	-1.5	-	1.5	%	Analog X and Y directions
Terminal Resistance	100	-	1300	ohm	X
	100	-	900	ohm	Y
Insulation Resistance	10	-	-	ohm	DC 25V
Voltage	-	5	7	V	DC
Chattering	-	-	10	Ms	100k pull-up
Transparency	78	-	-	%	JIS-K7105,ASTM D1003,@550nm

Note1: Do not operate it with a thing except a placental pen (tip R0.8mm or more) or a finger, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.

Note2: The figure below shows the connection of touch panel.





8.2 Mechanical& Reliability Characteristics

Item	Min	Typ	Max	Unit	Remark
Activation Force	-	-	80	g	Note1
Durability(Surface Scratching)	Write 100,000	-	-	characters	Note2
Durability(Surface Pitting)	1,000,000	-	-	touches	Note3
Surface Hardness	3	-	-	H	JIS-K5400, ASTM D3363

Note1: Stylus pen input: R0.8mm placental pen or finger.

Note2: Measurement for surface area:

Scratch 100,000 times straight line on the film with a stylus change every 20,000 times

Force: 250gf

Speed: 60 mm/sec

Stylus: R0.8 placental tip

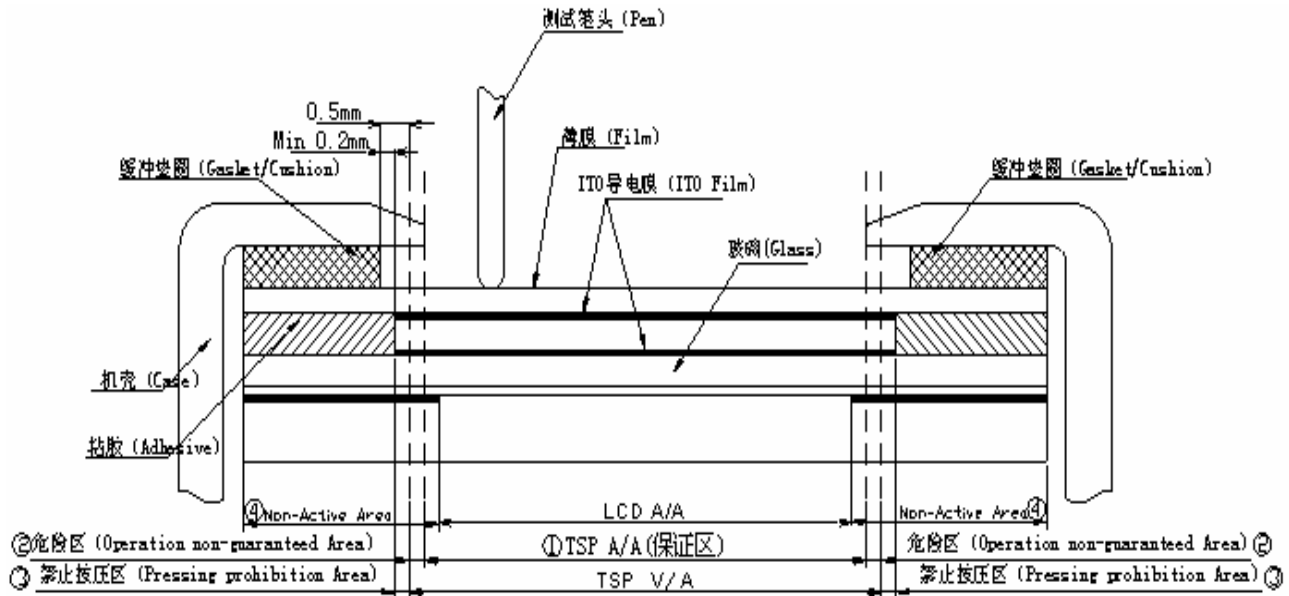
Note3: Pit 1,000,000 times on the film with a R8.0 silicon rubber.

Force: 250gf

Speed: 2 times/sec



9 Mechanical Design Guide



9.1 Explain

9.1.1 Active area

The area which guarantees a touch panel operation normally when pressed.

9.1.2 Operation non-guaranteed area

The area which does not guarantee a touch panel operation and its function. When this area is pressed, touch panel shows degradation of its performance and durability such as a pen sliding durability becomes about one-tenth compared. With the active area (Area-(a) as guaranteed area) and its operation force requires about double. About 0.5mm~1mm out side form a boundary of the active corresponds to this area.

9.1.3 Pressing prohibition area

The area which forbids pressing, because an excessive load is applied a transparent electrode and a serious damage is given to touch panel function by pressing.

9.1.4 Non-Active area

The area which does not activate even if passed.

9.2 The handling of sensitive area

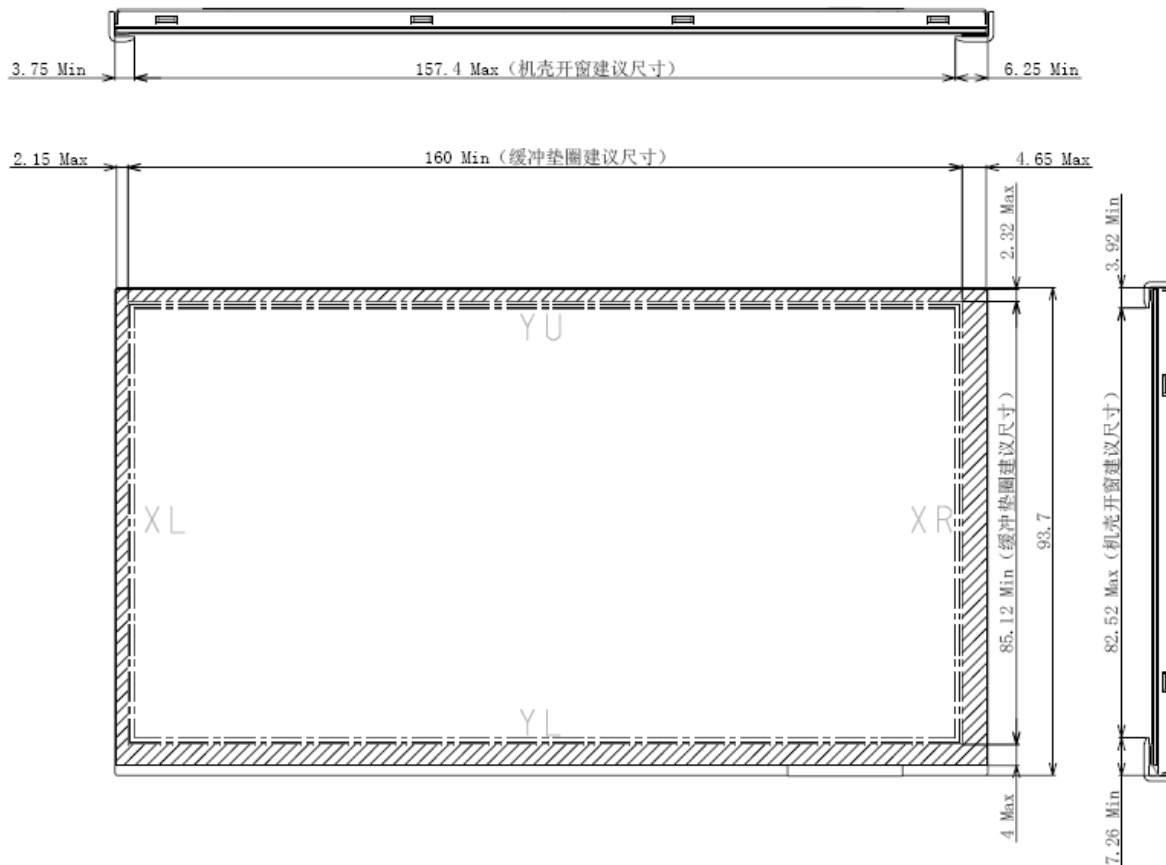
9.2.1 The sensitive area is between the edge of the double-side tape and the edge of the active area. Because the double-side tape has a certain height, the more transformative the ITO layer is pressed, the easier it would be to be broken. So it is suggested that pointed tools should be put away from the sensitive area to avoid them touching the sensitive area during operation.

9.2.2 When assembling the touch panel, it would be better to add a protective gasket on the surface of the product before assembling on to the housing. The gasket should be placed on the double-side tape and should not go beyond it.

9.2.3 If the housing is designed bigger than the active area, the edge of the sensitive area would be left outside of it. In addition, the protective gasket adds the thickness of this area, so do not use pens or other pointed tools to score along with the screen edge which may cause the damage of the ITO layer. If the panel is drawn with large force, the glass would even be broken.



9.2.4 If the housing is designed smaller than the active area, it can cover the sensitive area completely, in which case the scoring along with screen edge does no harm to the ITO layer. Nevertheless, due to the housing extending into the active area, the thickness of the gasket is very important. If it is too thick, the gap between the housing and the ITO film surface would be too wide which may affect the appearance of the product. If it is too thin, the housing would be pressed on the film surface which may cause short-circuit. The gap between the housing and the film should better be kept between 0.2mm and 0.3mm.



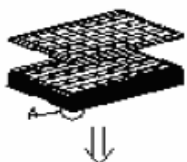




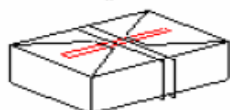
11 Packing Drawing

No	Item	Model(Material)	Dimensions (mm)	Unit Weight (Kg)	Quantity	Remark
1	LCM module	TM070RBH01	167.40x93.70x4.69	0.146	48	
2	Tray	PET(Transmit)	315x247x13	0.087	30	Anti-static
3	EPP	EPE	315x247x5	0.009	12	
4	Dust-Proof Bag	PE	700x545	0.05	1	
5	Box	Corrugated Paper	260x345x70	0.227	6	
6	Dust-Proof Bag	PE	327x270	0.021	6	
7	Carton	Corrugated Paper	544x365x250	1.01	1	
8	Total Weight (Kg)	12.274				

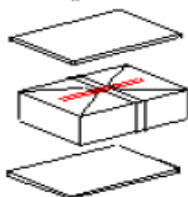
Use empty tray
+
Put products
into the 4 trays
2 LCM per tray



Use package bag



EPE
+
packing
+
EPE



Box
8 LCMs per Box



6 Box



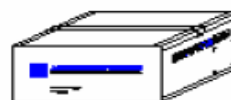
Use package bag



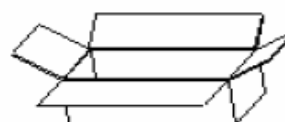
dust-proof bag



The tape to
seal carton



Put into
carton





12 TFT- LCD Module Incoming Inspection Standard

12.1 Scope

The incoming inspection standards shall be applied to TFT-LCD Modules (hereinafter called "Modules") that supplied by Shanghai Tianma Micro-Electronics Corporation.

12.2 Incoming Inspection

The customer shall inspect the modules within twenty calendar days of the delivery date (the "inspection period") at its own cost. The result of the inspection (acceptance or rejection) shall be recorded in writing, and a copy of this writing will be promptly sent to the seller, If the results of the inspecting from buyer does not send to the seller within twenty calendar days of the delivery date. The modules shall be regards as acceptance.

Should the customer fail to notify the seller within the inspection period, the buyer's right to reject the modules. Shall be lapsed and the modules shall be deemed to have been accepted by the buyer.

12.3 Inspection Sampling Method

Lot size: Quantity per shipment lot per model

Sampling type: Normal inspection, Single sampling

Inspection level: II

Sampling table: MIL-STD-105D

Acceptable quality level (AQL)

Major defect: AQL=0.65

Minor defect: AQL=1.00

12.4 Inspection Conditions

12.4.1 ambient conditions:

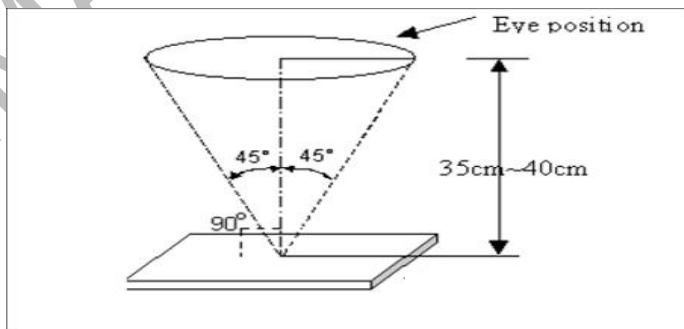
a. Temperature: Room temperature $25\pm 5^{\circ}\text{C}$

b. Humidity: $(60\pm 10)\% \text{RH}$

c. Illumination: Single fluorescent lamp non-directive (1000 to 1200 Lux)

12.4.2 The viewing distance between the LCD and the inspector's eyes shall be at least $30\pm 5\text{ cm}$.

12.4.3 Viewing Angle: U/D: $45^{\circ}/45^{\circ}$, L/R: $45^{\circ}/45^{\circ}$



12.5 Inspection Criteria

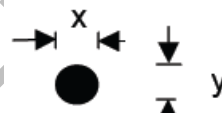
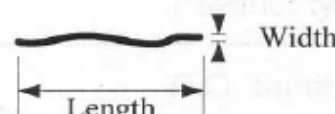
Defects are classified as major defects and minor defects according to the degree of defectiveness defined herein.




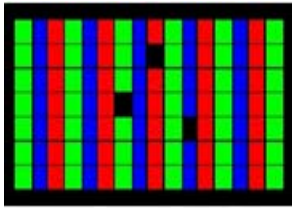
Major defect

Item	Inspection Standard
All Functional Defects	1) No display 2) Display abnormally 3) Short circuit 4) line defect
Missing	Missing function component
Crack	Glass Crack

Minor defect

No	Item	Inspection Standard	
1	Spot Defect (Including black spot and white spot)	$\varphi = (\bar{x} + \bar{y}) / 2$  <p>For black/white spot is defined</p>	
		Size φ (mm)	Acceptable Quantity
		$\varphi \leq 0.20$	Ignore
		$0.20 < \varphi \leq 0.30$	2
		$0.30 < \varphi \leq 0.40$	1
		$0.40 < \varphi$	Not allowed
2	Line Defect (Including black line, white line and scratch)	 <p>Define:</p>	
		Width(mm) Length(mm)	Acceptable Quantity
		$W \leq 0.03$	Ignore
		$0.03 < W \leq 0.1 \quad 0.8 < L \leq 2.0$	2
		$0.1 < W \text{ or } L > 2.0$	Not allowed
3	Polarizer Dent/Bubble	Size φ (mm)	Acceptable Quantity
		$\varphi \leq 0.1$	Ignore
		$0.1 < \varphi \leq 0.3$	2
		$0.3 < \varphi$	0



4	Electrical Dot Defect	Bright and black dot define:	
		 	
		Inspection pattern: Full white、Full black、Red、green and blue screens	
		Item	Acceptable Quantity
		Black dot defect	2
5	Touch Panel Scratch	Width(mm) Length(mm)	Acceptable Quantity
		$W \leq 0.03$	Ignore
		$0.03 < W \leq 0.1 \quad 0.8 < L \leq 2.0$	2
		$0.1 < W$ or $L > 2.0$	Not allowed
6	Touch Panel Bubble/Dent	Width(mm) Length(mm)	Acceptable Quantity
		$\phi \leq 0.20$	Ignore
		$0.20 < \phi \leq 0.30$	2
		$0.30 < \phi \leq 0.40$	1
		$0.40 < \phi$	Not allowed
7	TSP Bagginess	Size ϕ (mm)	Acceptable Quantity
		$D \leq 0.4$	Ignore
8	Newton Ring	Size ϕ (mm)	Acceptable Quantity
		$D < 15\text{mm}$	1

Note1: Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.

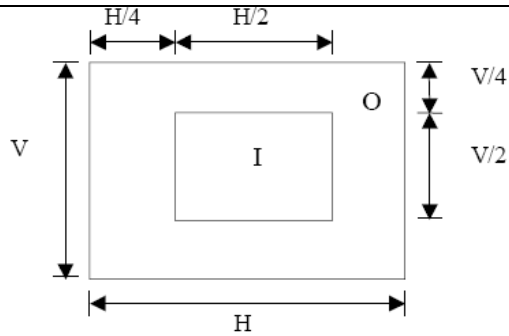
Note2: The distance between two bright dot defects (red, green, blue, and white) should be larger than 10mm.

Note3: The distance between black dot defects or black and bright dot defects should be more than 5mm apart.

Note4: The definitions of the inner display area and outer display area

I: Inner display area

O: Outer display area



Note5: Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.

12.6 Mechanics specification

As for the outside dimension, weight of the modules, please refer to product specification for more details



13 Precautions for Use of LCD Modules

13.1 Handling Precautions

13.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

13.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

13.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

13.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

13.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents

13.1.6 Do not attempt to disassemble the LCD Module.

13.1.7 If the logic circuit power is off, do not apply the input signals.

13.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

13.1.8.1 Be sure to ground the body when handling the LCD Modules.

13.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.

13.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

13.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

13.2 Storage precautions

13.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

13.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0℃ ~ 40℃ Relatively humidity: ≤80%

13.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

13.3 Transportation Precautions

13.3.1 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.